



Product Overview:

Comes with 4 ultra-efficient thermal heat pipes. Air cooling solution powered by Heat Core Touch Technology (HCTT) and equipped with high efficiency fins, TDP up to 140W. Compatible with most current motherboard designs: LGA 2066/2011/1150/1151/1155/1156/1366/775 and AM4/AM3+/AM3/AM2+/ AM2/FM2/FM1.

Specifications

Model		Verkho 4
Base Material		Aluminum block with HCTT Heat Core Touch Technology
Fin Material		Aluminum
Heat pipe		6mm x 4
Dimension		123 x 73 x 156.5mm
TDP(Thermal Design Power)		140
Fan	Speed	800-2000 rpm
	Connector	PWM 4-Pin
	Dimension	120 x 120 x 25mm
	Bearing Type	Hydraulic Bearing
	Started Voltage	5V
	Rated Voltage	12V
	Rated Current	0.26 A
	Power Consumption	3.12 Watts
	Air Pressure	0.78-1.24 mm-H2O
	Air Flow	27.2-56.4 CFM
	Noise	15-27 dBA
	MTBF (Mean Time Before Failure)	60000 hrs.
Socket		LGA 2066/2011/1150/1151/1155/1156/1366/775 AM4/AM3+/AM3/AM2+/AM2/FM2/FM1

ALL TRADEMARKS ARE REGISTERED TO THEIR RESPECTIVE OWNERS.

Warranty

2 years

Features

- TDP (Thermal Design Power) up to 140W.
- Compact side flow air cooler for maximum compatibility.
- Heat Core Touch Technology and 4 ultra-efficient thermal heat pipes.
- Upgraded high efficiency fins for optimal thermal performance.
- Ultra-slim profile, works with most current motherboard designs: LGA 2066/2011/1150/1151/1155/1156/1366/775 and AM4/AM3+/AM3/AM2+/AM2/FM2/FM1.

Package Information

Product Name	Product Number	EAN CODE
Verkho 4	ACTC-NA30410.01	410700955901

Carton Size (L x W x H)	476 x 300 x 380 mm	Carton Weight
Carton Qty	16 pcs	Pallet Qty

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